

Special Issue

Emerging and Exponential Technologies in Industry 4.0

Message from the Guest Editors

This Special Issue aims to explore the latest advancements and applications of progressive technologies within the context of Industry 4.0. Topics of interest include, but are not limited to, artificial intelligence, Internet of Things, Industrial Internet of Things, big data analytics, robotics, additive manufacturing, digital twin, as well as cyber-physical and embedded systems. Contributions focusing on innovative approaches, case studies, theoretical frameworks, and practical implementations that enhance industrial processes, efficiency, and sustainability are encouraged. You may choose our [Joint Special Issue](#) in *Sensors*.

Guest Editors

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Deadline for manuscript submissions

20 December 2025



Applied Sciences

an Open Access Journal
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Impact Factor 2.5
CiteScore 5.5



mdpi.com/si/205651

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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